

H13/B
OK
4/19/03

Docket No.
90065.001020/17732.8011.00

IN THE UNITED STATES PATENT & TRADEMARK OFFICE

Applicant	: Martin E. Kordes, et al.) Examiner:
Serial No.	: 09/682,151 ✓) Chris C. Chu
Filed	: 27 July 2001 ✓) Art Unit:
For	: CONTACT METHOD FOR THIN SILICON) 2815
	CARBIDE EPITAXIAL LAYER AND)
	SEMICONDUCTOR DEVICES FORMED BY)
	THOSE METHODS ✓)

Assistant Commissioner For Patents
Washington, DC 20231

AMENDMENT

In response to the office action mailed January 2, 2003, Applicants hereby amend the specification and drawings and will promptly submit a supplemental declaration.

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2815

AMENDMENT TRANSMITTAL LETTER (Large Entity)

Applicant(s): Martin E. Kordes, et al.

Docket No.

90065.001020/17732.8011.00

Serial No.
09/682,151

Filing Date
July 27, 2001

Examiner
Chris C. Shu

Group Art Unit
2815

Invention: **CONTACT METHOD FOR THIN SILICON CARBIDE EPITAXIAL LAYER AND SEMICONDUCTOR DEVICES FORMED BY THOSE METHODS**

TO THE ASSISTANT COMMISSIONER FOR PATENTS:

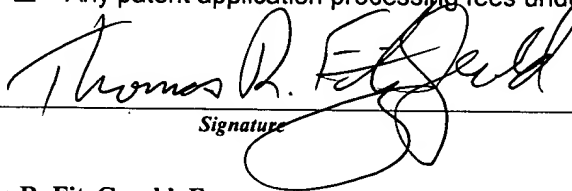
Transmitted herewith is an amendment in the above-identified application.

The fee has been calculated and is transmitted as shown below.

CLAIMS AS AMENDED

	CLAIMS REMAINING AFTER AMENDMENT	HIGHEST # PREV. PAID FOR	NUMBER EXTRA CLAIMS PRESENT	RATE	ADDITIONAL FEE
TOTAL CLAIMS	15 -	20 =	0 x	\$18.00	\$0.00
INDEP. CLAIMS	2 -	3 =	0 x	\$84.00	\$0.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					\$0.00
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT					\$0.00

- ☒ No additional fee is required for amendment.
- ☐ Please charge Deposit Account No. _____ in the amount of _____
A duplicate copy of this sheet is enclosed.
- ☐ A check in the amount of _____ to cover the filing fee is enclosed.
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- ☐ Any additional filing fees required under 37 C.F.R. 1.16.
- ☐ Any patent application processing fees under 37 CFR 1.17.


Signature

Dated:

4/2/03

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I certify that this document and fee is being deposited on April 2, 2003 with the U.S. Postal Service as first class mail under 37 C.F.R. 1.8 and is addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.


Signature of Person Mailing Correspondence

Kathleen A. Manczuk

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I hereby certify that this Amendment (7 pages)

(Identify type of correspondence)

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Assistant Commissioner for Patents, Washington, D.C. 20231 on

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